



ZXM62P02E6

20V P-CHANNEL ENHANCEMENT MODE MOSFET

SUMMARY

$V_{(BR)DSS}=-20V$; $R_{DS(ON)}=0.20\Omega$; $I_D=-2.3A$

DESCRIPTION

This new generation of high density MOSFETs from Zetex utilises a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, power management applications.

FEATURES

- Low on-resistance
- Fast switching speed
- Low threshold
- Low gate drive
- SOT23-6 package

APPLICATIONS

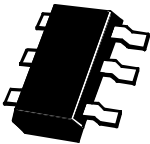
- DC - DC Converters
- Power Management Functions
- Disconnect switches
- Motor control

ORDERING INFORMATION

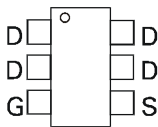
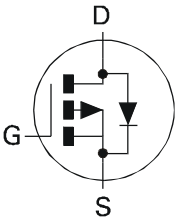
DEVICE	REEL SIZE (inches)	TAPE WIDTH (mm)	QUANTITY PER REEL
ZXM62P02E6TA	7	8mm embossed	3000 units
ZXM62P02E6TC	13	8mm embossed	10000 units

DEVICE MARKING

- 2P02



SOT23-6



Top View



ZXM62P02E6

ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DSS}	-20	V
Gate- Source Voltage	V_{GS}	± 12	V
Continuous Drain Current ($V_{GS}=-4.5V$; $T_A=25^\circ C$)(b) ($V_{GS}=-4.5V$; $T_A=70^\circ C$)(b)	I_D	-2.3 -1.7	A
Pulsed Drain Current (c)	I_{DM}	-13	A
Continuous Source Current (Body Diode)(b)	I_S	-1.9	A
Pulsed Source Current (Body Diode)(c)	I_{SM}	-13	A
Power Dissipation at $T_A=25^\circ C$ (a) Linear Derating Factor	P_D	1.1 8.8	W mW/ $^\circ C$
Power Dissipation at $T_A=25^\circ C$ (b) Linear Derating Factor	P_D	1.7 13.6	W mW/ $^\circ C$
Operating and Storage Temperature Range	$T_j:T_{stg}$	-55 to +150	$^\circ C$

THERMAL RESISTANCE

PARAMETER	SYMBOL	VALUE	UNIT
Junction to Ambient (a)	$R_{\theta JA}$	113	$^\circ C/W$
Junction to Ambient (b)	$R_{\theta JA}$	73	$^\circ C/W$

NOTES

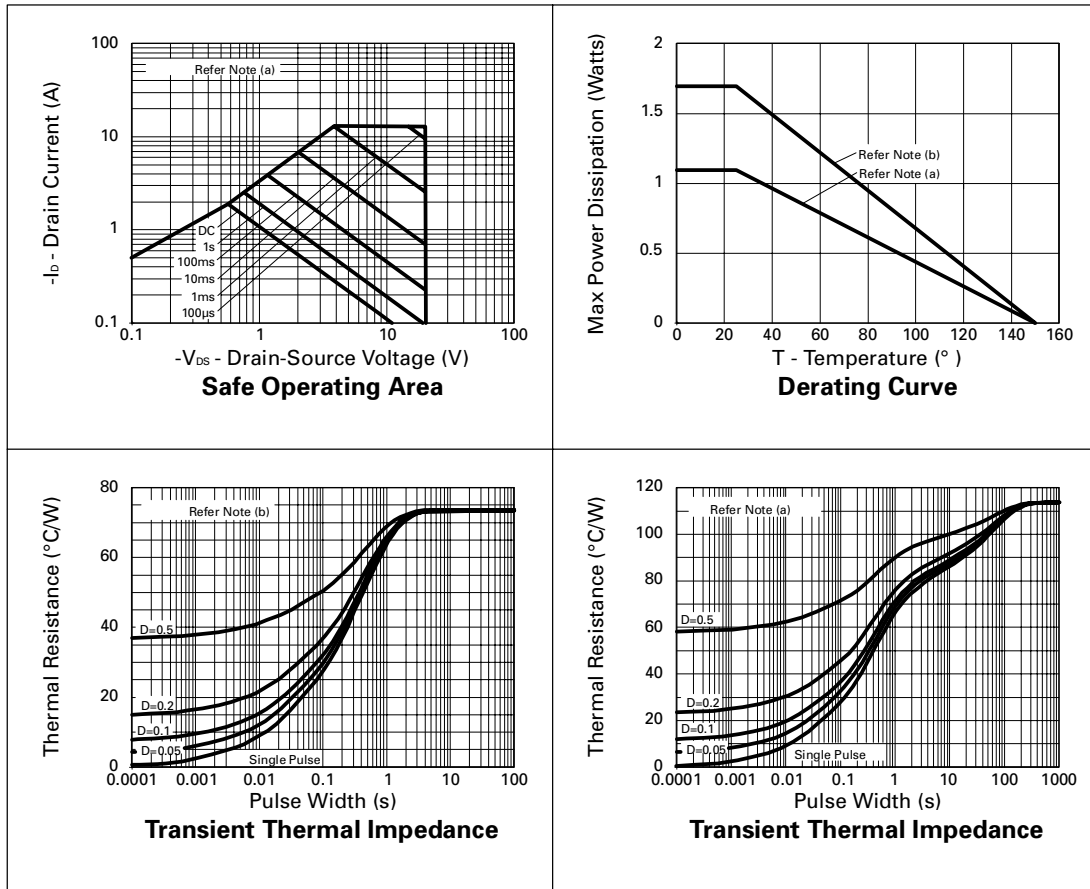
(a) For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions

(b) For a device surface mounted on FR4 PCB measured at $t \leq 5$ secs.

(c) Repetitive rating - pulse width limited by maximum junction temperature. Refer to Transient Thermal Impedance graph.

ZXM62P02E6

CHARACTERISTICS



ZXM62P02E6

ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25^{\circ}\text{C}$ unless otherwise stated).

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	-20			V	I _D =-250μA, V _{GS} =0V
Zero Gate Voltage Drain Current	I _{DSS}			-1	μA	V _{DS} =-20V, V _{GS} =0V
Gate-Body Leakage	I _{GSS}			±100	nA	V _{GS} =± 12V, V _{DS} =0V
Gate-Source Threshold Voltage	V _{GS(th)}	-0.7			V	I _D =-250μA, V _{DS} = V _{GS}
Static Drain-Source On-State Resistance (1)	R _{DS(on)}			0.2 0.375	Ω Ω	V _{GS} =-4.5V, I _D =-1.6A V _{GS} =-2.7V, I _D =-0.8A
Forward Transconductance (3)	g _{fs}	1.5			S	V _{DS} =-10V,I _D =-0.8A
DYNAMIC (3)						
Input Capacitance	C _{iss}		320		pF	V _{DS} =-15 V, V _{GS} =0V, f=1MHz
Output Capacitance	C _{oss}		150		pF	
Reverse Transfer Capacitance	C _{rss}		75		pF	
SWITCHING(2) (3)						
Turn-On Delay Time	t _{d(on)}		4.1		ns	V _{DD} =-10V, I _D =-1.6A R _G =6.0Ω, R _D =6.1Ω (Refer to test circuit)
Rise Time	t _r		15.4		ns	
Turn-Off Delay Time	t _{d(off)}		12.0		ns	
Fall Time	t _f		19.2		ns	
Total Gate Charge	Q _g			5.8	nC	V _{DS} =-16V,V _{GS} =-4.5V, I _D =-1.6A (Refer to test circuit)
Gate-Source Charge	Q _{gs}			1.25	nC	
Gate Drain Charge	Q _{gd}			2.8	nC	
SOURCE-DRAIN DIODE						
Diode Forward Voltage (1)	V _{SD}			-0.95	V	T _j =25°C, I _S =-1.6A, V _{GS} =0V
Reverse Recovery Time (3)	t _{rr}		22.5		ns	T _j =25°C, I _F =-1.6A, di/dt= 100A/μs
Reverse Recovery Charge(3)	Q _{rr}		10.4		nC	

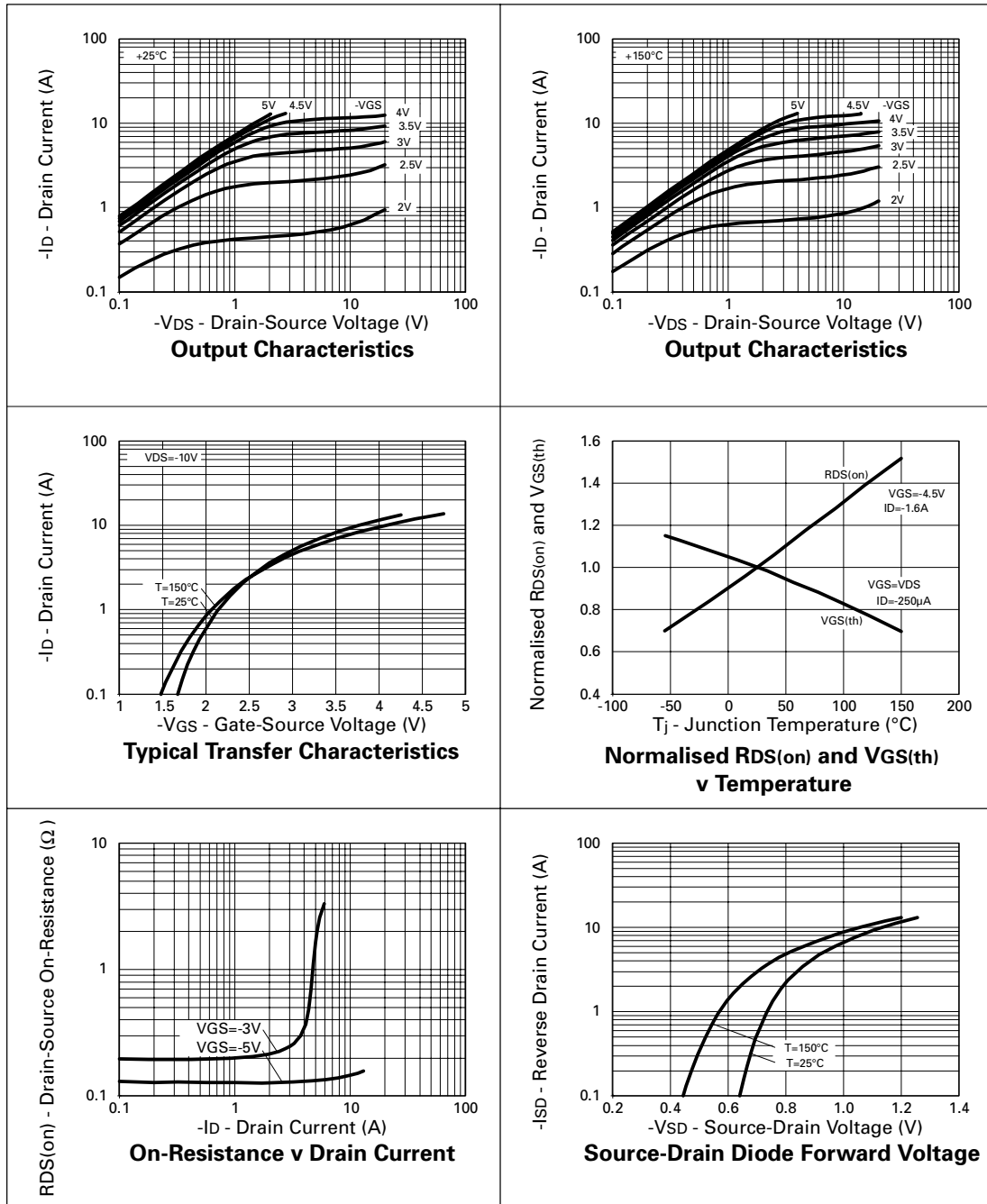
(1) Measured under pulsed conditions. Width=300 μs . Duty cycle $\leq 2\%$.

(2) Switching characteristics are independent of operating junction temperature.

(3) For design aid only, not subject to production testing.

ZXM62P02E6

TYPICAL CHARACTERISTICS

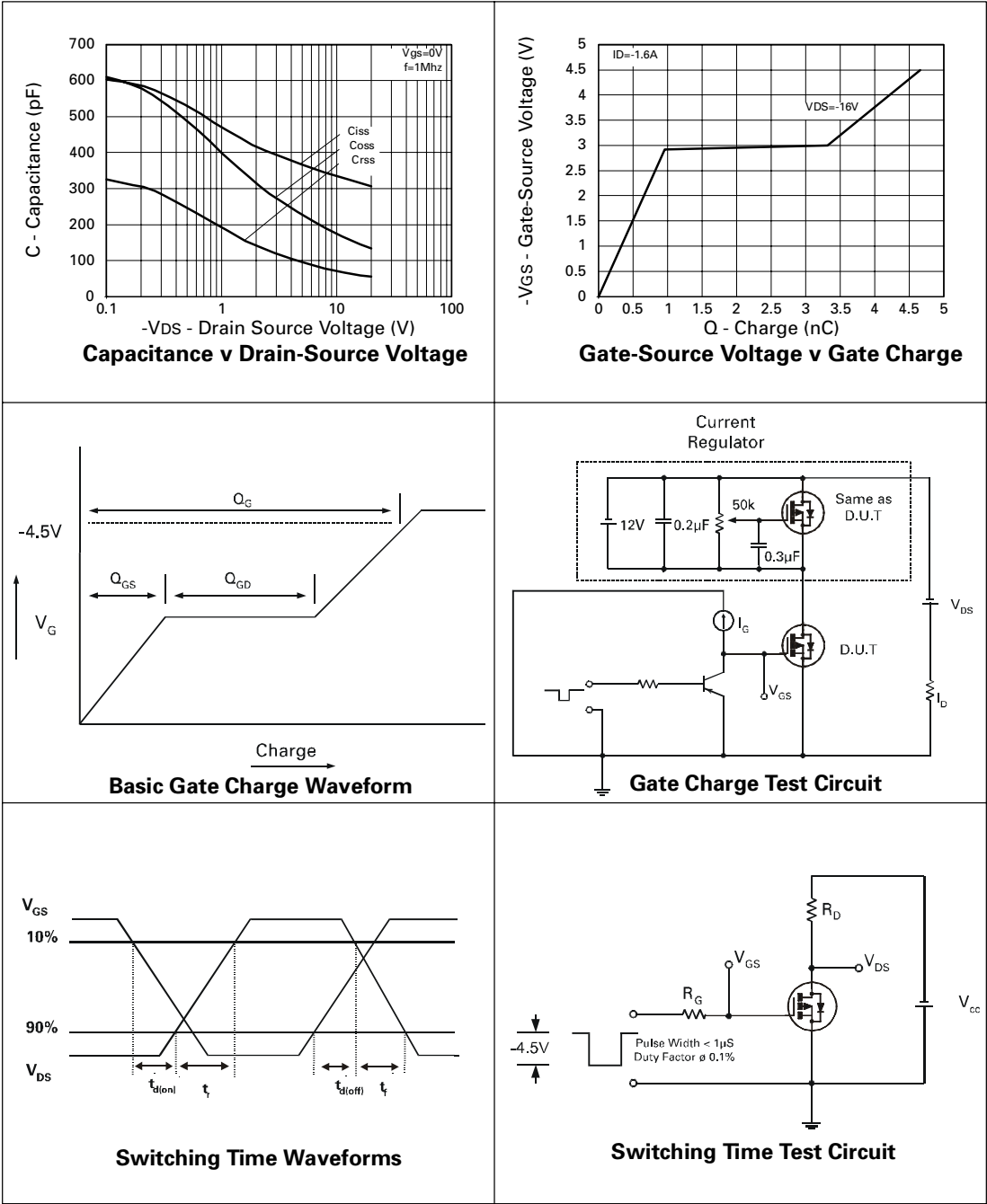


PROVISIONAL ISSUE A - JULY 1999



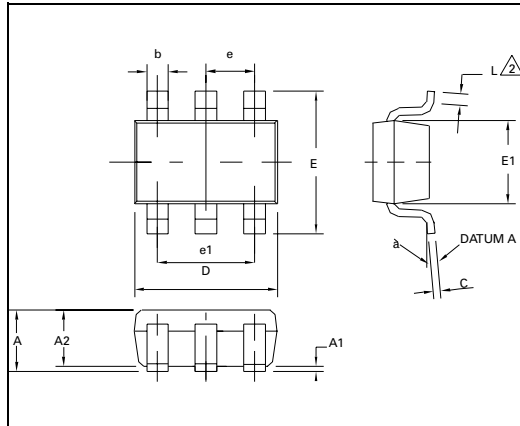
ZXM62P02E6

TYPICAL CHARACTERISTICS

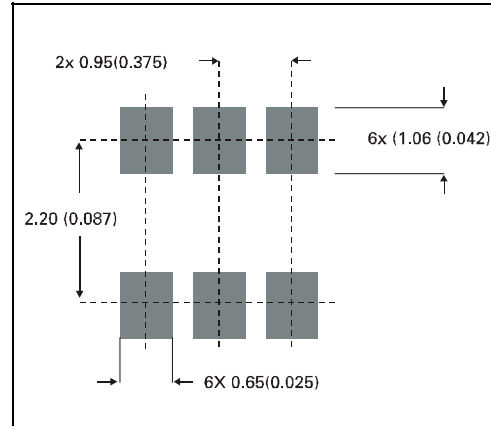


ZXM62P02E6

PACKAGE DIMENSIONS



PAD LAYOUT DETAILS



DIM	Millimetres		Inches	
	Min	Max	Min	Max
A	0.90	1.45	0.35	0.057
A1	0.00	0.15	0	0.006
A2	0.90	1.30	0.035	0.051
b	0.35	0.50	0.014	0.019
C	0.09	0.20	0.0035	0.008
D	2.80	3.00	0.110	0.118
E	2.60	3.00	0.102	0.118
E1	1.50	1.75	0.059	0.069
L	0.10	0.60	0.004	0.002
e	0.95 REF		0.037 REF	
e1	1.90 REF		0.074 REF	
L	0°	10°	0°	10°



ZETEX

Zetex plc.
Fields New Road, Chadderton, Oldham, OL9-8NP, United Kingdom.
Telephone: (44)161 622 4422 (Sales), (44)161 622 4444 (General Enquiries)
Fax: (44)161 622 4420

Zetex GmbH
Streitfeldstraße 19
D-81673 München
Germany
Telefon: (49) 89 45 49 49 0
Fax: (49) 89 45 49 49 49

Zetex Inc.
47 Mall Drive, Unit 4
Commack NY 11725
USA
Telephone: (516) 543-7100
Fax: (516) 864-7630

Zetex (Asia) Ltd.
3510 Metroplaza, Tower 2
Hing Fong Road,
Kwai Fong, Hong Kong
Telephone: (852) 26100 611
Fax: (852) 24250 494

These are supported by
agents and distributors in
major countries world-wide
©Zetex plc 1999

Internet: <http://www.zetex.com>

This publication is issued to provide outline information only which (unless agreed by the Company in writing) may not be used, applied or reproduced for any purpose or form part of any order or contract or be regarded as a representation relating to the products or services concerned. The Company reserves the right to alter without notice the specification, design, price or conditions of supply of any product or service.

PROVISIONAL ISSUE A - JULY 1999

ZETEX